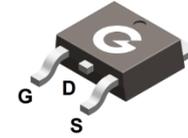
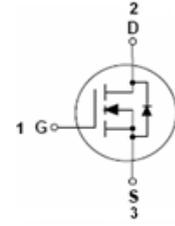


YK2N20D

Features

- Advanced Trench technology
- Low gate drive voltage (Logic level capable)
- Low input capacitance
- Low on-resistance
- Fast switching speed
- RoHS compliant with Halogen-free

HF



TO-252

Mechanical Data

- Case: TO-252
- Molding Compound: UL Flammability Classification Rating 94V-0
- Terminals: Matte tin-plated leads; solderability-per MIL-STD-202, Method 208

Ordering Information

Part Number	Package	Shipping Quantity	Marking Code
YK2N20D	TO-252	80 pcs / Tube or 2500 pcs / Tape & Reel	2N20D

Maximum Ratings (@ $T_C = 25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain-to-Source Voltage	V_{DSS}	200	V
Gate-to-Source Voltage	V_{GSS}	± 20	V
Continuous Drain Current ($T_C = 25^\circ\text{C}$)	I_D	5	A
Continuous Drain Current ($T_A = 25^\circ\text{C}$) ^{*1}		1.6	A
Pulsed Drain Current ($t_p = 10\mu\text{s}$, $T_C = 25^\circ\text{C}$)	I_{DM}	20	A
Single Pulse Avalanche Energy ^{*3}	E_{AS}	1	mJ

Thermal Characteristics

Parameter	Symbol	Value	Unit
Power Dissipation ($T_C = 25^\circ\text{C}$)	P_D	30	W
Thermal Resistance Junction-to-Csae	$R_{\theta JC}$	4.2	$^\circ\text{C/W}$
Thermal Resistance Junction-to-Air ^{*1}	$R_{\theta JA}$	40.3	$^\circ\text{C/W}$
Operating Junction Temperature Range	T_J	-55 ~ +150	$^\circ\text{C}$
Storage Temperature Range	T_{STG}	-55 ~ +150	$^\circ\text{C}$

YK2N20D

Electrical Characteristics (@ T_A = 25°C unless otherwise specified)

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
Static Characteristics						
V _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0V, I _D = 250μA	200	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 200V, V _{GS} = 0V	-	-	1	μA
I _{GSS}	Gate-Body Leakage Current	V _{GS} = ±20V, V _{DS} = 0V	-	-	±100	nA
On Characteristics						
R _{DS(ON)}	Drain-Source On-resistance ^{*2}	V _{GS} = 10V, I _D = 2A	-	0.65	0.75	Ω
		V _{GS} = 5V, I _D = 2A	-	0.67	0.78	Ω
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D = 250μA	1	1.6	2.5	V
Dynamic Characteristics						
C _{ISS}	Input Capacitance	V _{GS} = 0V V _{DS} = 25V f = 1.0MHz	-	580	-	pF
C _{OSS}	Output Capacitance		-	90	-	
C _{RSS}	Reverse Transfer Capacitance		-	3	-	
Switching Characteristics						
t _{d(ON)}	Turn-on Delay Time ^{*4}	V _{DD} = 100V V _{GS} = 10V R _G = 2.5Ω R _L = 15Ω	-	10	-	ns
t _r	Turn-on Rise Time ^{*4}		-	12	-	
t _{d(OFF)}	Turn-Off Delay Time ^{*4}		-	15	-	
t _f	Turn-Off Fall Time ^{*4}		-	15	-	
Q _G	Total Gate-Charge	V _{DD} = 100V V _{GS} = 10V I _D = 2A	-	12	-	nC
Q _{GS}	Gate to Source Charge		-	2.5	-	
Q _{GD}	Gate to Drain (Miller) Charge		-	3.8	-	
Source-Drain Diode Characteristics						
V _{SD}	Diode Forward Voltage ^{*2}	I _{SD} = 2A, V _{GS} = 0V	-	0.86	0.95	V
t _{rr}	Reverse recovery time	I _S = 2A, V _{GS} = 0V, di/dt = 100A/μs	-	177	-	ns
Q _{rr}	Reverse recovery charge		-	1.4	-	μC

Notes:

1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper
2. The data tested by pulsed, pulse width ≤ 300μs, duty cycle ≤ 2%
3. The E_{AS} data shows Max. rating. The test condition is V_{DD} = 50V, V_{GS} = 10V, L = 0.5mH
4. Guaranteed by design, not subject to production

YK2N20D

Ratings and Characteristics Curves (@ $T_A = 25^\circ\text{C}$ unless otherwise specified)

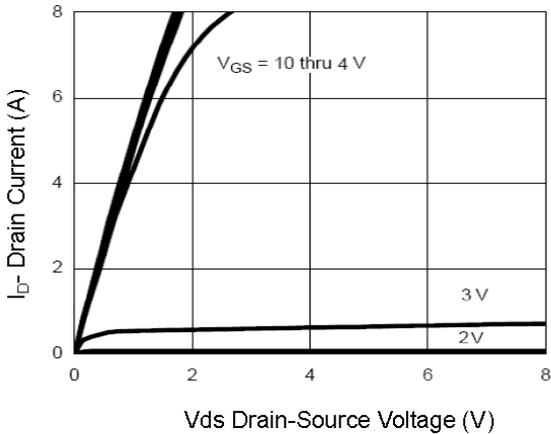


Figure 1 Output Characteristics

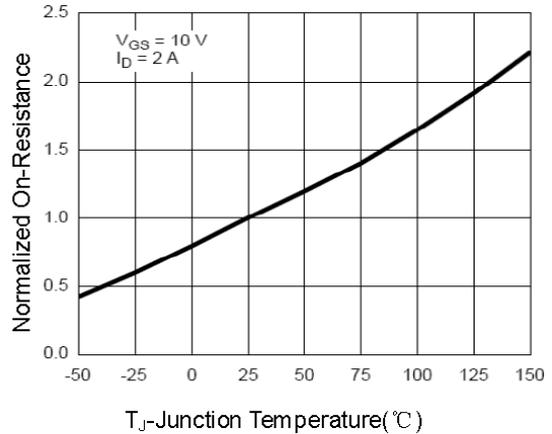


Figure 4 Rdson-Junction Temperature

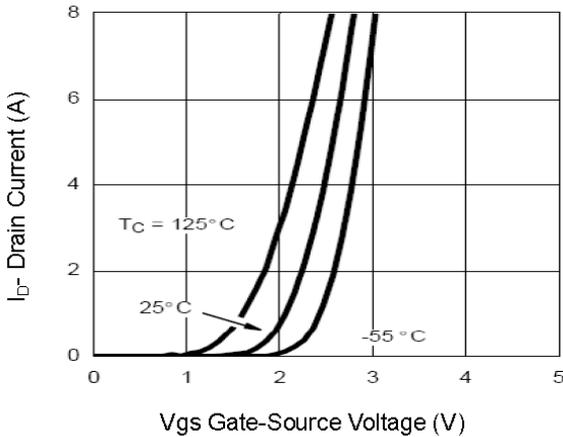


Figure 2 Transfer Characteristics

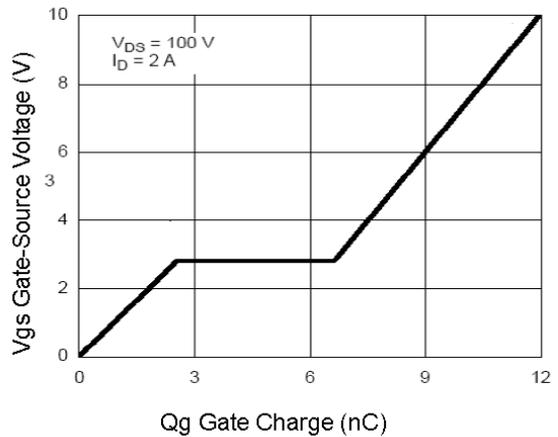


Figure 5 Gate Charge

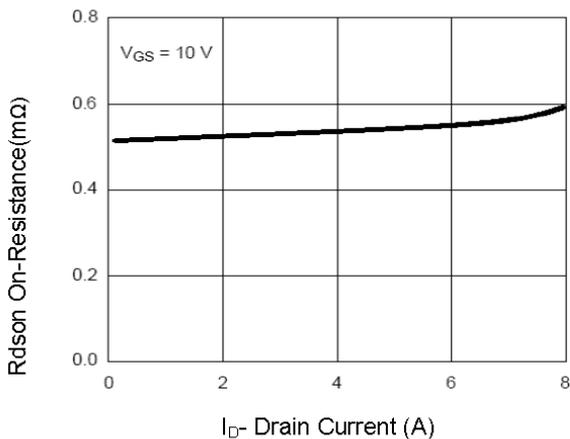


Figure 3 Rdson- Drain Current

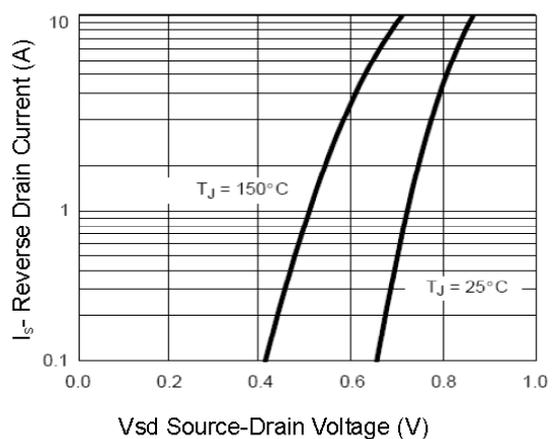


Figure 6 Source- Drain Diode Forward

YK2N20D

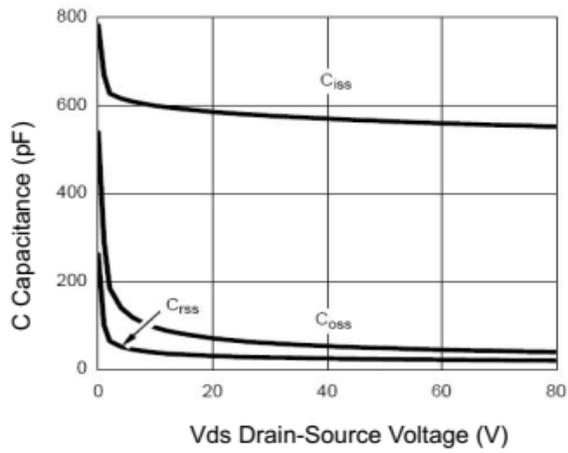


Figure 7 Capacitance vs Vds

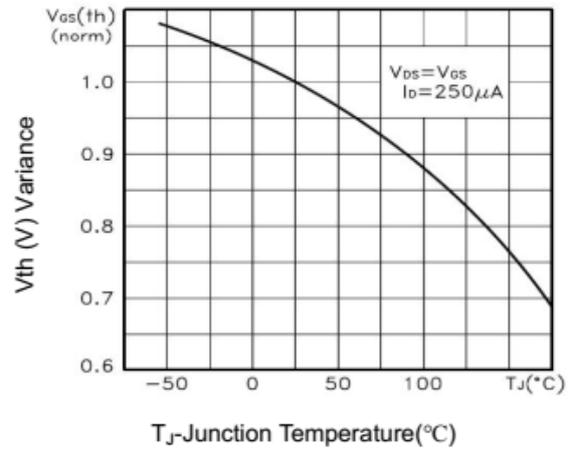


Figure 9 V_{GS(th)} vs Junction Temperature

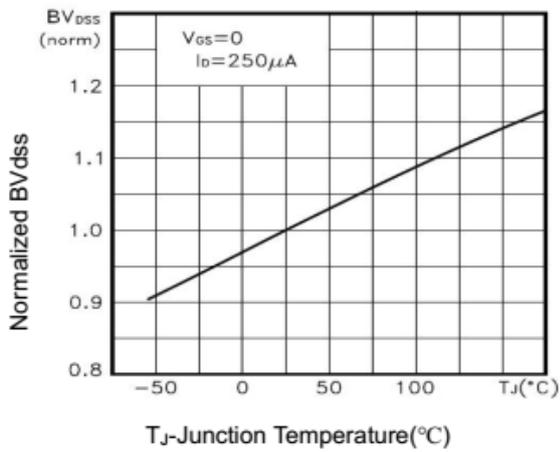
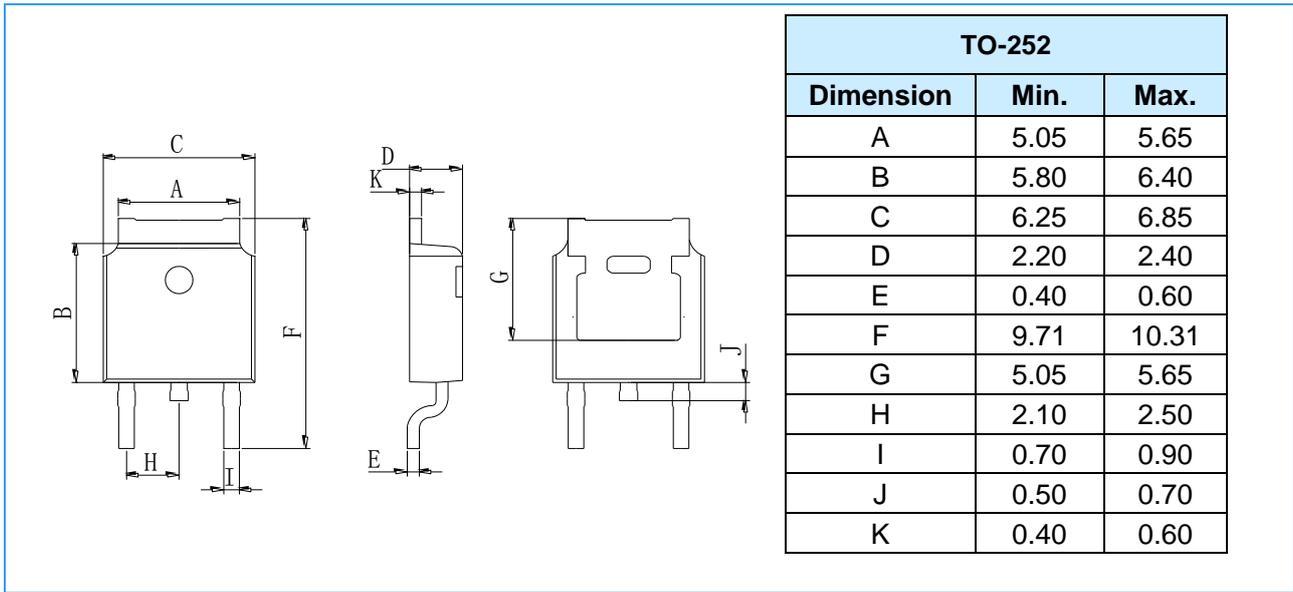


Figure 8 BV_{DSS} vs Junction Temperature

YK2N20D

Package Outline Dimensions (Unit: mm)



Mounting Pad Layout (Unit: mm)

